507849266 04/12/2023

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1 Stylesheet Version v1.2 EPAS ID: PAT7896402

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
TOSHIO NAGASAWA	03/31/2023
NAOTAKA KOIDE	03/31/2023

RECEIVING PARTY DATA

Name:	KABUSHIKI KAISHA TOSHIBA	
Street Address:	1-1, SHIBAURA 1-CHOME	
City:	MINATO-KU, TOKYO	
State/Country:	JAPAN	
Postal Code:	105-0023	
Name:	TOSHIBA ELECTRONIC DEVICES & STORAGE CORPORATION	
Name: Street Address:	TOSHIBA ELECTRONIC DEVICES & STORAGE CORPORATION 1-1, SHIBAURA 1-CHOME	
Street Address:	1-1, SHIBAURA 1-CHOME	

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	18117515

CORRESPONDENCE DATA

Fax Number: (202)683-3999

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent

using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

Phone: 2026833800

Email: aopatents@allenovery.com, docketing.allenovery@clarivate.com

Correspondent Name: ALLEN & OVERY LLP
Address Line 1: 1101 NEW YORK AVE NW

Address Line 2: DAVID M. TENNANT

Address Line 4: WASHINGTON, D.C. 20005

ATTORNEY DOCKET NUMBER: 0137280-0000001-084-101	
NAME OF SUBMITTER:	DAVID M. TENNANT
SIGNATURE:	/David M. Tennant/

PATENT 507849266 REEL: 063297 FRAME: 0363

DATE SIGNED:	04/12/2023	
	This document serves as an Oath/Declaration (37 CFR 1.63).	
Total Attachments: 2		
source=0137280-0000001-084-101_Assignment#page1.tif		
source=0137280-0000001-084-101_Assignment#page2.tif		

PATENT REEL: 063297 FRAME: 0364

DECLARATION (37 CFR 1.63) FOR UTILITY OR DESIGN APPLICATION USING AN APPLICATION DATA SHEET (37 CFR 1.76) AND ASSIGNMENT FOR MULTIPLE ASSIGNEES

Title of				
Title of Invention	SEMICONDUCTOR INTEGRATED CIRCUIT			
As the below named inventor, I hereby declare that:				
This declaratio	on The attached application, or			
is directed to:	✓ United States application or PCT international application number			
	filed on <u>March 6, 2023</u>			
The above-ide	ntified application was made or authorized to be made by me.			
I believe that I am the original inventor or an original joint inventor of a claimed invention in the application.				
WHEREAS,	(1) KABUSHIKI KAISHA TOSHIBA			
	(2) Toshiba Electronic Devices & Storage Corporation			
(hereinafter ref	ferred to as "ASSIGNEES") having places of business at:			
(1) 1-1, Shib	aura 1-chome, Minato-ku, Tokyo, 105-0023, Japan			
	aura 1-chome, Minato-ku, Tokyo, 105-0023, Japan			
	re desirous of jointly acquiring interests in the entire right, title and interest in and to said invention			
	ny Letters Patent that may be granted therefore in the United States and its territorial possessions and			
in any and all f	foreign countries;			
NOW THE	REFORE, in consideration of the sum of FIVE DOLLARS (\$5.00), the receipt whereof is hereby			
	, and for other good and valuable consideration, I, by these presents do sell, assign and transfer unto			
_	EES, the full and exclusive right to the said invention in the United States and its territorial possessions			
	gn countries (including the right to claim priority under the terms of the International Convention and			
	International Treaties and Arrangements from the aforesaid application) and the entire right, title and			
	to any and all Letters Patent which may be granted therefor in the United States and its territorial			
possessions and in any and all foreign countries and in and to any and all divisions, reissues, continuations,				
•	nd renewals thereof.			
-	horize and request the Patent Office Officials in the United States and its territorial possessions and			
any and all foreign countries to issue any and all of said Letters Patent, when granted, to said ASSIGNEES as the				
assignees of my entire right, title and interest in and to the same, for the sole use and behoof of said ASSIGNEES, their successors and assigns, to the full end of the term for which said Letters Patent may be granted, as fully and				
entirely as the same would have been held by me had this Assignment and sale not been made.				
entirely as the	same would have been neld by the had this Assignment and safe not been made.			
Further, I agree that I will communicate to said ASSIGNEES or their representatives any facts known to me				
respecting said invention, and testify in any legal proceeding, sign all lawful papers, execute all divisional,				
continuation, substitute, renewal and reissue applications, execute all necessary assignment papers to cause any and				
all of said Letters Patent to be issued to said ASSIGNEES, make all rightful oaths, and, generally do everything				
possible to aid said ASSIGNEES, their successors and assigns, to obtain and enforce proper protection for said				
invention in the United States and its territorial possessions and in any and all foreign countries.				
I hereby acknowledge that any willful false statement made in this declaration is punishable under 18 U.S.C. 1001				
by fine or imprisonment of not more than five (5) years, or both.				
LEGAL NAM	E OF INVENTOR			
Inventor: To	oshio Nagasawa Date: 03/31/2023			
mvemor	Date.			
Signature:	/Toshio Nagasawa/			

PATENT REEL: 063297 FRAME: 0365

ADG10040818-US-A (22F0511)

SUPPLEMENTAL SHEET FOR DECLARATION	ADDITIONAL INVENTOR(S) Supplemental Sheet(for PTO/AIA/08,09)	Page 2 of 2
Legal Name of Additional Joint Inventor, if any		
(2) Naotaka Koide		
Inventor's Signature /Naotaka Koide/	03/3 Date(Option	31/2023 nal)

PATENT REEL: 063297 FRAME: 0366

RECORDED: 04/12/2023